

J559-VB Datasheet

P-Channel 20 V (D-S) MOSFET



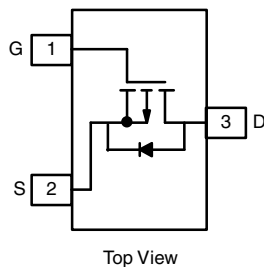
PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (TYP.) (nC)
-20	0.450 at V _{GS} = -10 V	-0.40	1
	0.500 at V _{GS} = -4.5 V	-0.36	
	0.600 at V _{GS} = -2.5 V	-0.32	

FEATURES

- TrenchFET® power MOSFET
- 100 % R tested
- Fast switching speed

APPLICATIONS

- Load / power switch for portable devices
- Drivers: relays, solenoids, displays
- Battery operated systems



ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	-20	V
Gate-Source Voltage		V _{GS}	± 20	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	-0.40 ^{b, c}	A
	T _A = 70 °C		-0.31 ^{b, c}	
Pulsed Drain Current (t = 300 μs)		I _{DM}	-1.6	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	-0.16 ^{b, c}	
Maximum Power Dissipation	T _A = 25 °C	P _D	0.19 ^{b, c}	W
	T _A = 70 °C		0.12 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient ^{a, b}	t ≤ 5 s	R _{thJA}	440	530	°C/W
	Steady State		540	650	

Notes

- a. Maximum under steady state conditions is 650 °C/W.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.

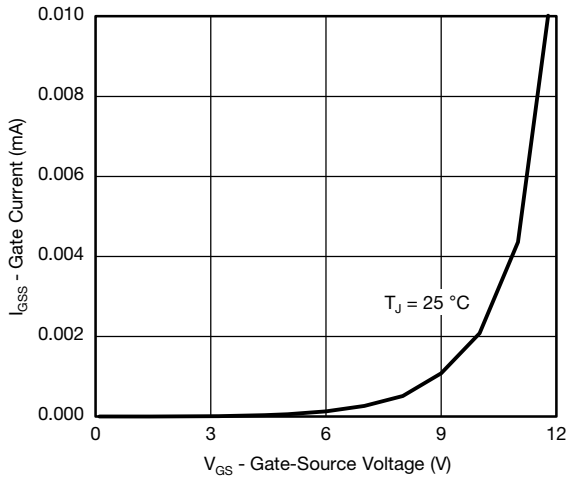
SPECIFICATIONS ($T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0, I_D = -250\ \mu\text{A}$	-20	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = -250\ \mu\text{A}$	-	-12	-	mV/ $^\circ\text{C}$
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$		-	1.8	-	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\ \mu\text{A}$	-0.6	-	-1.5	V
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0\ \text{V}, V_{GS} = \pm 8\ \text{V}$	-	-	± 30	μA
		$V_{DS} = 0\ \text{V}, V_{GS} = \pm 4.5\ \text{V}$	-	-	± 1	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -20\ \text{V}, V_{GS} = 0\ \text{V}$	-	-	-1	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} = -20\ \text{V}, V_{GS} = 0\ \text{V}, T_J = 85\text{ }^\circ\text{C}$	-	-	-10	A
		$V_{DS} = \geq 5\ \text{V}, V_{GS} = -4.5\ \text{V}$	-1.5	-	-	
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = -10\ \text{V}, I_D = -0.4\ \text{A}$	-	0.450	-	Ω
		$V_{GS} = -4.5\ \text{V}, I_D = -0.2\ \text{A}$	-	0.500	-	
		$V_{GS} = -2.5\ \text{V}, I_D = -0.1\ \text{A}$	-	0.600	-	
Forward Transconductance	g_{fs}	$V_{DS} = -10\ \text{V}, I_D = 0.4\ \text{A}$	-	1	-	S
Dynamic ^b						
Input Capacitance	C_{iss}	$V_{DS} = -10\ \text{V}, V_{GS} = 0\ \text{V}, f = 1\ \text{MHz}$	-	45	-	μF
Output Capacitance	C_{oss}		-	15	-	
Reverse Transfer Capacitance	C_{rss}		-	10	-	
Total Gate Charge	Q_g	$V_{DS} = -10\ \text{V}, V_{GS} = -4.5\ \text{V}, I_D = -0.4\ \text{A}$	-	1.65	2.50	nC
		$V_{DS} = -0\ \text{V}, V_{GS} = -2.5\ \text{V}, I_D = -0.4$	-	1	2	
Gate-Source Charge	Q_{gs}	$V_{DS} = -0\ \text{V}, V_{GS} = -2.5\ \text{V}, I_D = -0.4$	-	0.2	-	
Gate-Drain Charge	Q_{gd}	$V_{DS} = -0\ \text{V}, V_{GS} = -2.5\ \text{V}, I_D = -0.4$	-	0.26	-	
Gate Resistance	R_g	$f = 1\ \text{MHz}$	2.4	12	24	Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -10\ \text{V}, R_L = 33.3\ \Omega$ $I_D \cong -0.3\ \text{A}, V_{GEN} = -4.5\ \text{V}, R_g = 1\ \Omega$	-	9	18	ns
Rise Time	t_r		-	10	20	
Turn-Off Delay Time	$t_{d(off)}$		-	10	20	
Fall Time	t_f		-	8	16	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -10\ \text{V}, R_L = 33.3\ \Omega$ $I_D \cong -0.3\ \text{A}, V_{GEN} = -8\ \text{V}, R_g = 1\ \Omega$	-	1	2	
Rise Time	t_r		-	8	16	
Turn-Off Delay Time	$t_{d(off)}$		-	9	18	
Fall Time	t_f		-	5	10	
Drain-Source Body Diode Characteristics						
Pulse Diode Forward Current ^a	I_{SM}		-	-	-1.5	A
Body Diode Voltage	V_{SD}	$I_S = -0.3\ \text{A}$	-	-0.8	-1.2	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = -0.3\ \text{A}, di/dt = 100\ \text{A}/\mu\text{s}$	-	16	24	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	8	16	nC
Reverse Recovery Fall Time	t_a		-	11	-	ns
Reverse Recovery Rise Time	t_b		-	5	-	

Notes

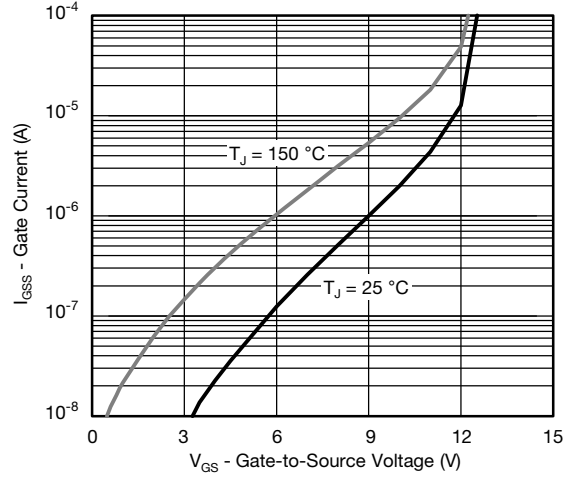
- a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
 b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

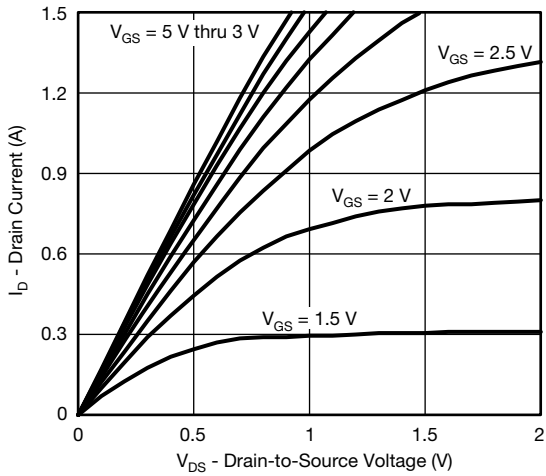
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



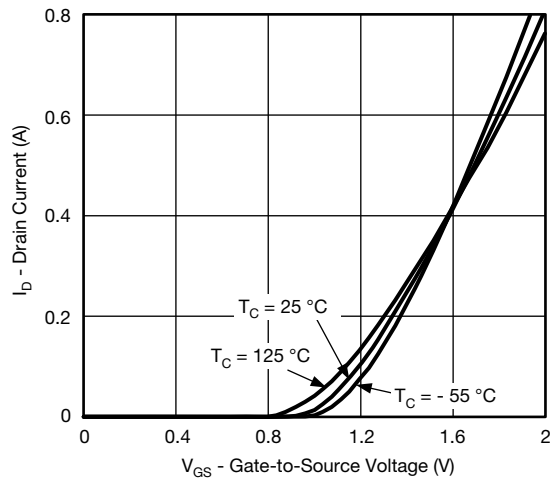
Gate Current vs. Gate-Source Voltage



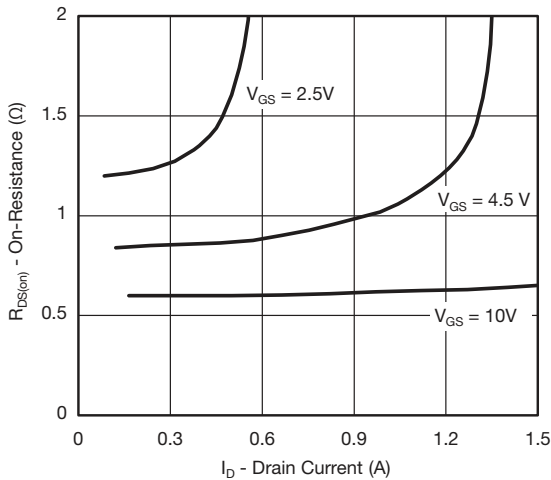
Gate Current vs. Gate-Source Voltage



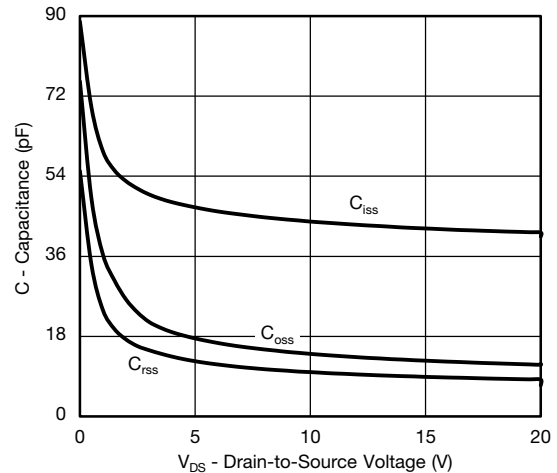
Output Characteristics



Transfer Characteristics

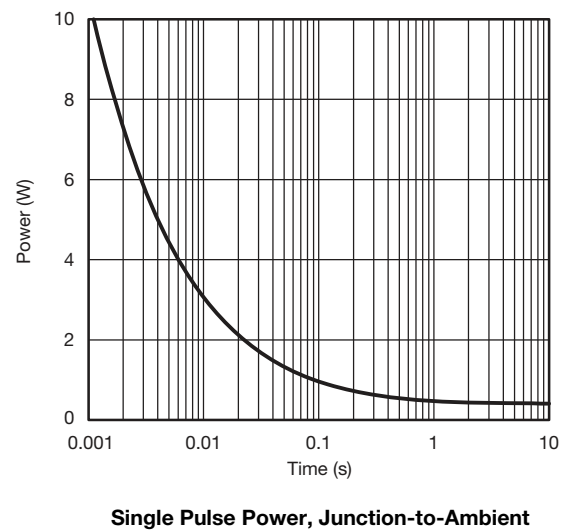
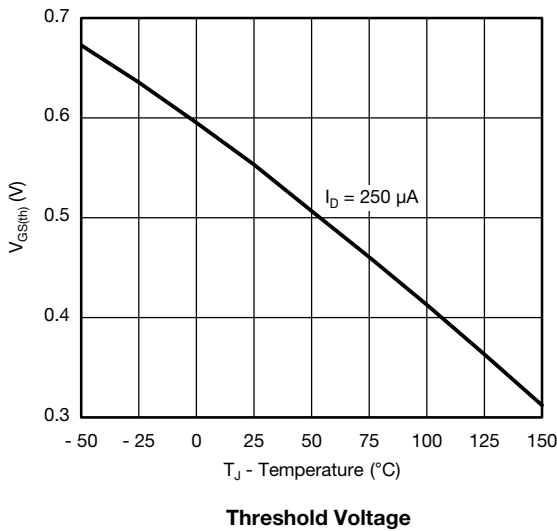
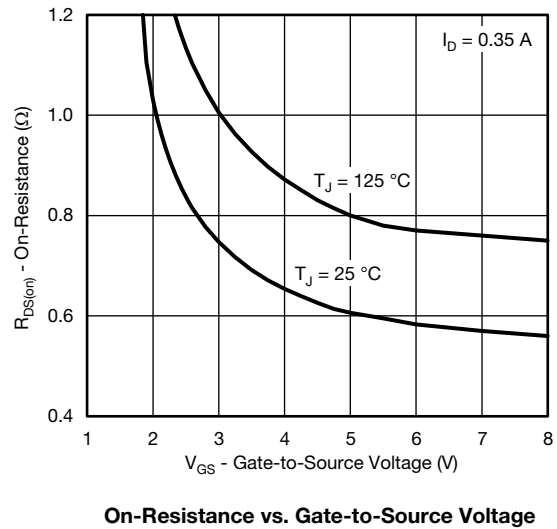
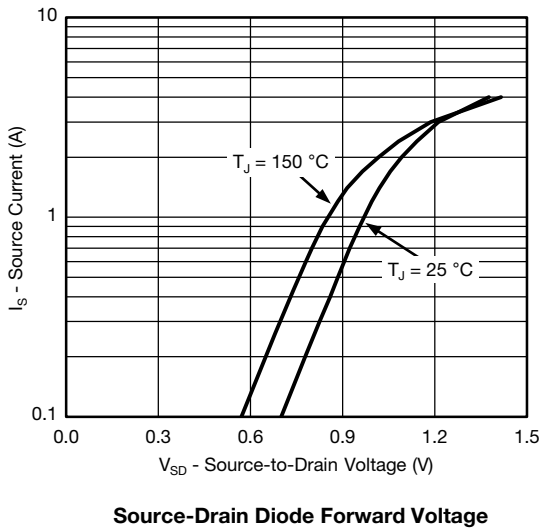
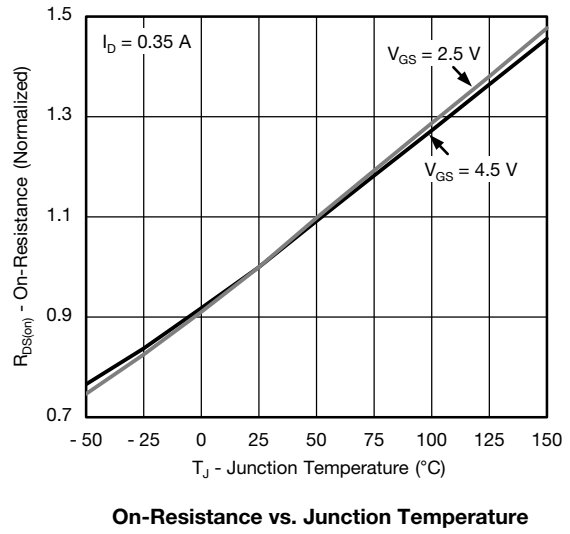
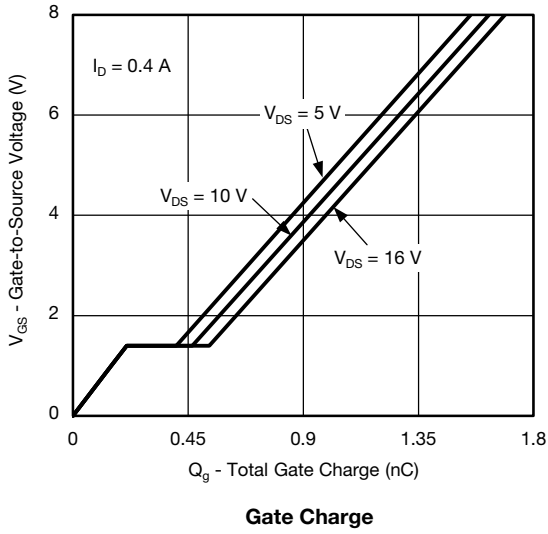


On-Resistance vs. Drain Current

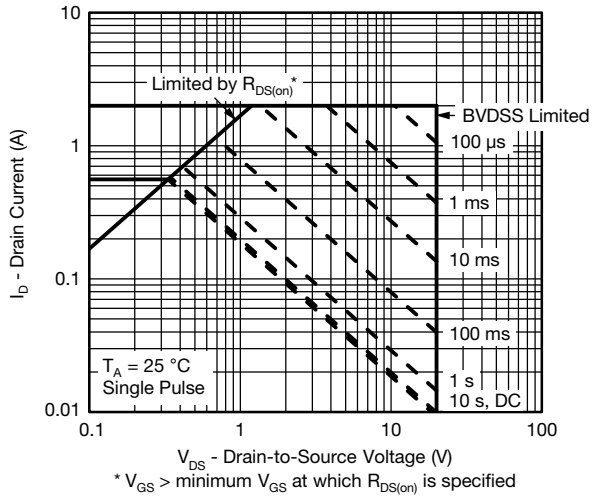


Capacitance

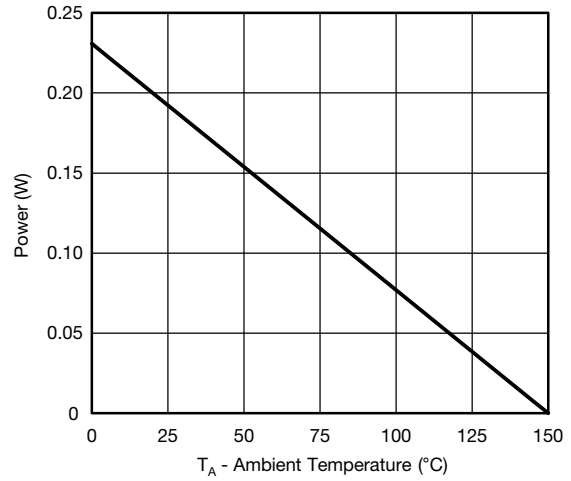
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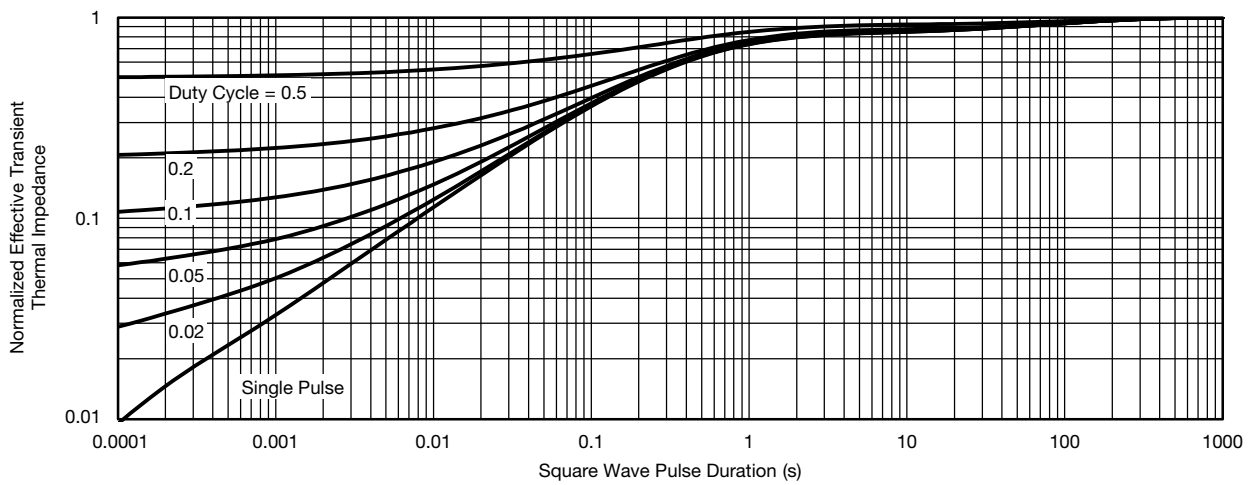
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient

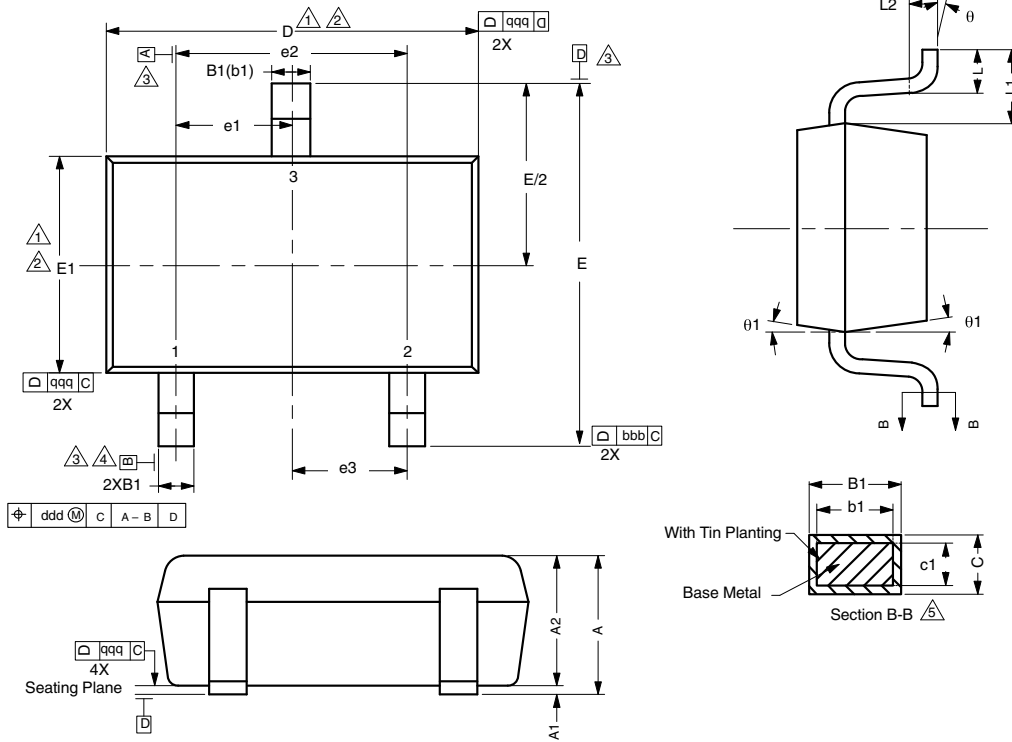


Power Derating, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient

SC-75A: 3 Leads



DWG: 5868

Notes

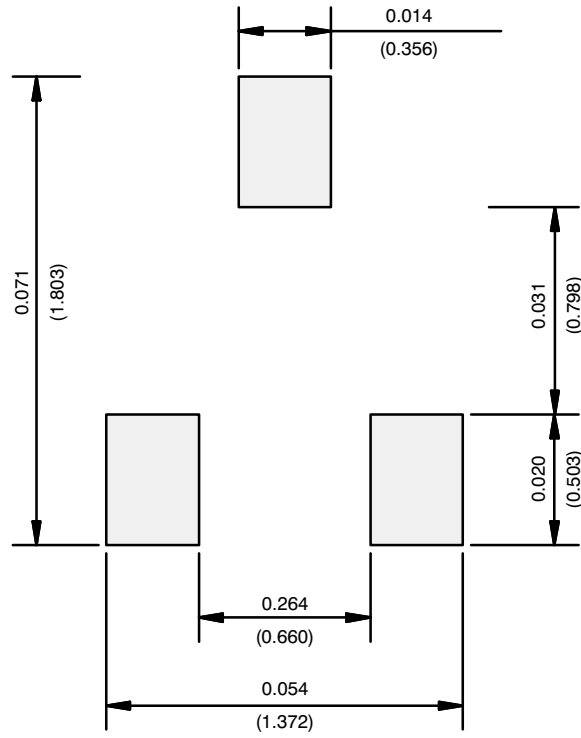
Dimensions in millimeters will govern.

- ① Dimension D does not include mold flash, protrusions or gate burrs. Mold flash protrusions or gate burrs shall not exceed 0.10 mm per end. Dimension E1 does not include Interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.10 mm per side.
- ② Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.
- ③ Datums A, B and D to be determined 0.10 mm from the lead tip.
- ④ Terminal positions are shown for reference only.
- ⑤ These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

DIMENSIONS	TOLERANCES
aaa	0.10
bbb	0.10
ccc	0.10
ddd	0.10

DIM.	MILLIMETERS			NOTE
	MIN.	NOM.	MAX.	
A	-	-	0.80	
A1	0.00	-	0.10	
A2	0.65	0.70	0.80	
B1	0.19	-	0.24	5
b1	0.17	-	0.21	
c	0.13	-	0.15	5
c1	0.10	-	0.12	5
D	1.48	1.575	1.68	1, 2
E	1.50	1.60	1.70	
E1	0.66	0.76	0.86	1, 2
e1	0.50 BSC			
e2	1.00 BSC			
e3	0.50 BSC			
L	0.15	0.205	0.30	
L1	0.40 ref.			
L2	0.15 BSC			
q	0°	-	8°	
q1	4°	-	10°	

RECOMMENDED MINIMUM PADS FOR SC-75A: 3-Lead



Recommended Minimum Pads
Dimensions in Inches/(mm)

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